

SN54LV161A, SN74LV161A 4-BIT SYNCHRONOUS BINARY COUNTERS

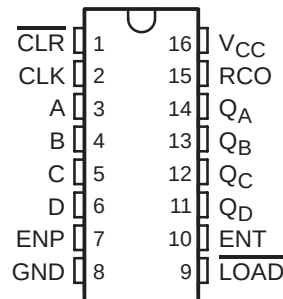
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- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 9.5 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce)
<0.8 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot)
>2.3 V at $V_{CC} = 3.3$ V, $T_A = 25^\circ\text{C}$
- Support Mixed-Mode Voltage Operation on All Ports
- Internal Look-Ahead for Fast Counting
- Carry Output for n-Bit Cascading
- Synchronous Counting
- Synchronously Programmable
- I_{off} Supports Partial-Power-Down Mode Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

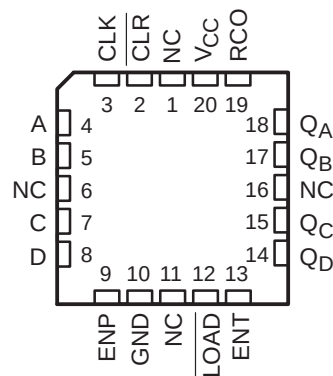
description/ordering information

The 'LV161A devices are 4-bit synchronous binary counters designed for 2-V to 5.5-V V_{CC} operation.

SN54LV161A . . . J OR W PACKAGE
SN74LV161A . . . D, DB, DGV, NS, OR PW PACKAGE
(TOP VIEW)



SN54LV161A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	SOIC – D	Tube of 40	SN74LV161AD	LV161A
		Reel of 2500	SN74LV161ADR	
	SOP – NS	Reel of 2000	SN74LV161ANSR	74LV161A
	SSOP – DB	Reel of 2000	SN74LV161ADBR	LV161A
	TSSOP – PW	Tube of 90	SN74LV161APW	LV161A
		Reel of 2000	SN74LV161APWR	
		Reel of 250	SN74LV161APWT	
	TVSOP – DGV	Reel of 2000	SN74LV161ADGVR	LV161A
–55°C to 125°C	CDIP – J	Tube of 25	SNJ54LV161AJ	SNJ54LV161AJ
	CFP – W	Tube of 150	SNJ54LV161AW	SNJ54LV161AW
	LCCC – FK	Tube of 55	SNJ54LV161AFK	SNJ54LV161AFK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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**TEXAS
INSTRUMENTS**

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SN54LV161A, SN74LV161A

4-BIT SYNCHRONOUS BINARY COUNTERS

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description/ordering information (continued)

These synchronous, presettable counters feature an internal carry look-ahead for application in high-speed counting designs. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincident with each other when so instructed by the count-enable (ENP, ENT) inputs and internal gating. This mode of operation eliminates the output counting spikes that normally are associated with synchronous (ripple-clock) counters. A buffered clock (CLK) input triggers the four flip-flops on the rising (positive-going) edge of the clock waveform.

These counters are fully programmable; that is, they can be preset to any number between 0 and 9 or 15. As presetting is synchronous, setting up a low level at the load input disables the counter and causes the outputs to agree with the setup data after the next clock pulse, regardless of the levels of the enable inputs.

The clear function for the 'LV161A devices is asynchronous. A low level at the clear ($\overline{\text{CLR}}$) input sets all four of the flip-flop outputs low, regardless of the levels of the CLK, load ($\overline{\text{LOAD}}$), or enable inputs.

The carry look-ahead circuitry provides for cascading counters for n-bit synchronous applications without additional gating. Instrumental in accomplishing this function are ENP, ENT, and a ripple-carry output (RCO). Both ENP and ENT must be high to count, and ENT is fed forward to enable RCO. Enabling RCO produces a high-level pulse while the count is maximum (9 or 15 with Q_A high). This high-level overflow ripple-carry pulse can be used to enable successive cascaded stages. Transitions at ENP or ENT are allowed, regardless of the level of CLK.

These counters feature a fully independent clock circuit. Changes at control inputs (ENP, ENT, or $\overline{\text{LOAD}}$) that modify the operating mode have no effect on the contents of the counter until clocking occurs. The function of the counter (whether enabled, disabled, loading, or counting) is dictated solely by the conditions meeting the stable setup and hold times.

These devices are fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down.

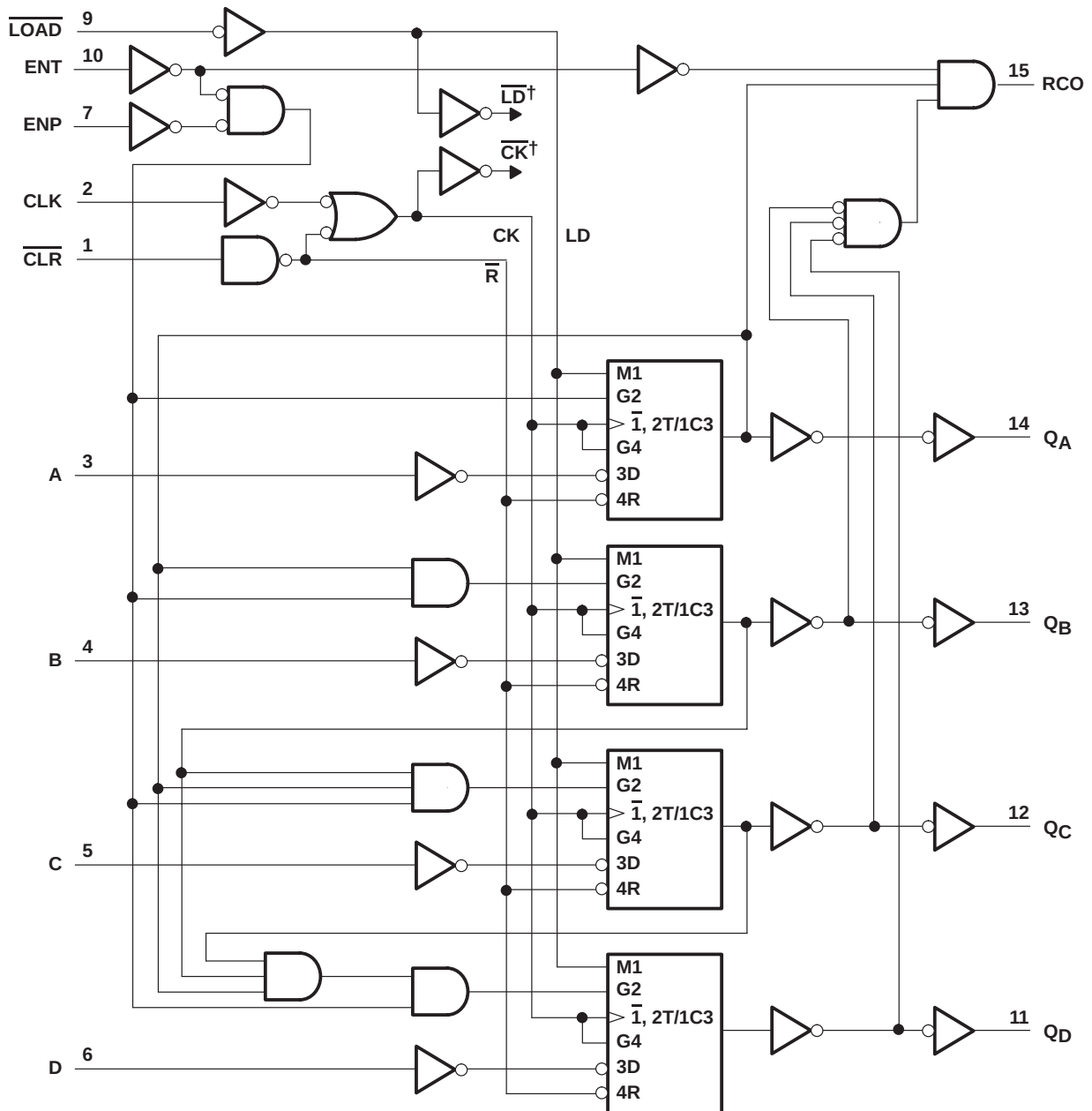
FUNCTION TABLE

INPUTS					OUTPUTS				FUNCTION
$\overline{\text{CLR}}$	$\overline{\text{LOAD}}$	ENP	ENT	CLK	QA	QB	QC	QD	
L	X	X	X	X	L	L	L	L	Reset to "0"
H	L	X	X	↑	A	B	C	D	Preset Data
H	H	X	L	↑	No Change				No Count
H	H	L	X	↑	No Change				No Count
H	H	H	H	↑	Count up				Count
H	X	X	X	↑	No Change				No Count

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logic diagram (positive logic)



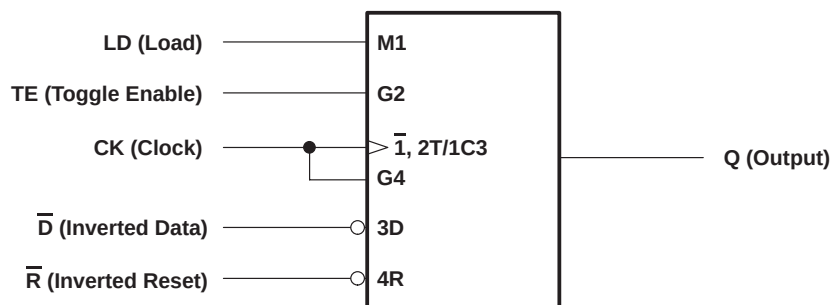
† For simplicity, routing of complementary signals $\overline{LD}$ and $\overline{CK}$ is not shown on this overall logic diagram. The uses of these signals are shown on the logic diagram of the D/T flip-flops.

Pin numbers shown are for the D, DB, DGV, J, NS, PW, and W packages.

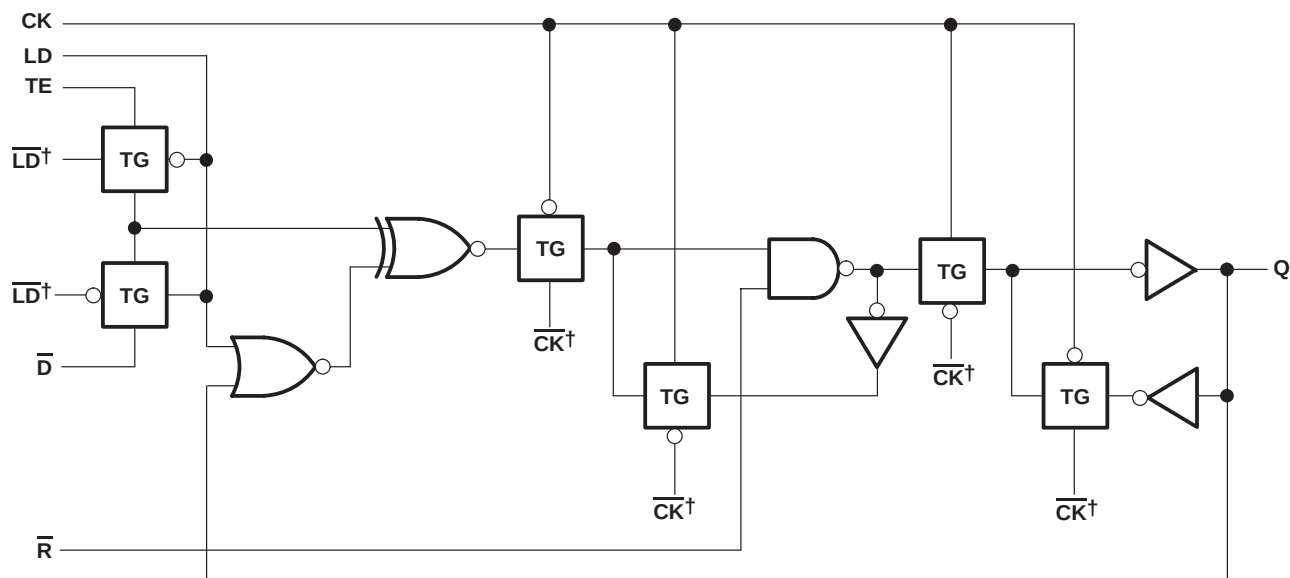
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logic symbol, each D/T flip-flop



logic diagram, each D/T flip-flop (positive logic)

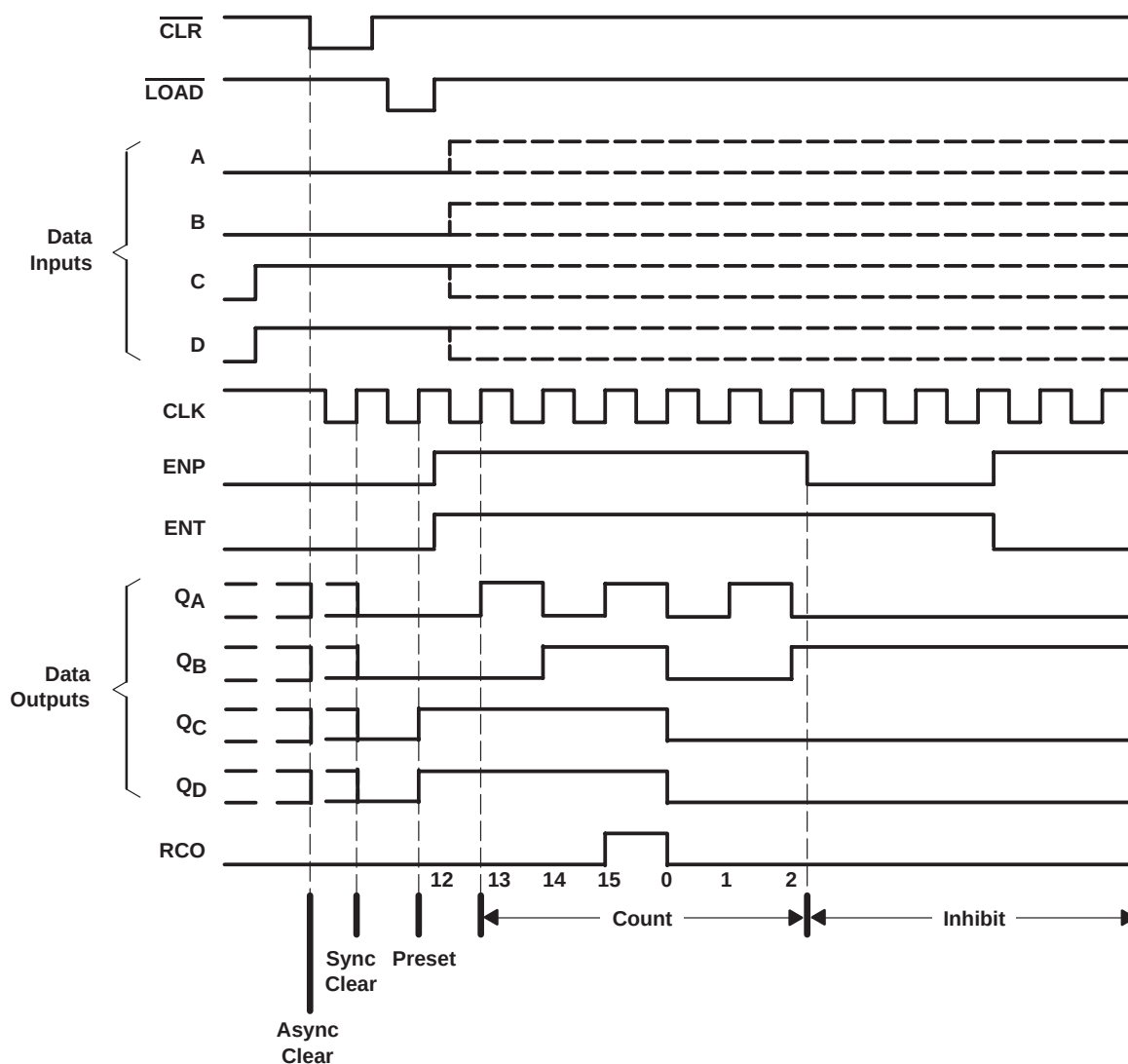


† The origins of $\overline{LD}$ and $\overline{CK}$ are shown in the overall logic diagram of the device.

typical clear, preset, count, and inhibit sequence

The following sequence is illustrated below:

1. Clear outputs to zero (asynchronous)
2. Preset to binary 12
3. Count to 13, 14, 15, 0, 1, and 2
4. Inhibit



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4-BIT SYNCHRONOUS BINARY COUNTERS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7 V
Output voltage range applied in high or low state, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Voltage range applied to any output in the power-off state, V_O (see Note 1)	–0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V_{CC} or GND	±50 mA
Package thermal impedance, θ_{JA} (see Note 3): D package	73°C/W
DB package	82°C/W
DGV package	120°C/W
NS package	64°C/W
PW package	108°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
 2. This value is limited to 5.5 V maximum.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

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recommended operating conditions (see Note 4)

			SN54LV161A		SN74LV161A		UNIT
			MIN	MAX	MIN	MAX	
V _{CC}	Supply voltage		2	5.5	2	5.5	V
V _{IH}	High-level input voltage	V _{CC} = 2 V	1.5		1.5		V
		V _{CC} = 2.3 V to 2.7 V	V _{CC} × 0.7		V _{CC} × 0.7		
		V _{CC} = 3 V to 3.6 V	V _{CC} × 0.7		V _{CC} × 0.7		
		V _{CC} = 4.5 V to 5.5 V	V _{CC} × 0.7		V _{CC} × 0.7		
V _{IL}	Low-level input voltage	V _{CC} = 2 V	0.5		0.5		V
		V _{CC} = 2.3 V to 2.7 V	V _{CC} × 0.3		V _{CC} × 0.3		
		V _{CC} = 3 V to 3.6 V	V _{CC} × 0.3		V _{CC} × 0.3		
		V _{CC} = 4.5 V to 5.5 V	V _{CC} × 0.3		V _{CC} × 0.3		
V _I	Input voltage		0	5.5	0	5.5	V
V _O	Output voltage		0	V _{CC}	0	V _{CC}	V
I _{OH}	High-level output current	V _{CC} = 2 V	−50		−50		μA
		V _{CC} = 2.3 V to 2.7 V	−2		−2		mA
		V _{CC} = 3 V to 3.6 V	−6		−6		
		V _{CC} = 4.5 V to 5.5 V	−12		−12		
I _{OL}	Low-level output current	V _{CC} = 2 V	50		50		μA
		V _{CC} = 2.3 V to 2.7 V	2		2		mA
		V _{CC} = 3 V to 3.6 V	6		6		
		V _{CC} = 4.5 V to 5.5 V	12		12		
Δt/Δv	Input transition rise or fall rate	V _{CC} = 2.3 V to 2.7 V	0	200	0	200	ns/V
		V _{CC} = 3 V to 3.6 V	0	100	0	100	
		V _{CC} = 4.5 V to 5.5 V	0	20	0	20	
T _A	Operating free-air temperature		−55	125	−40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{CC}	SN54LV161A			SN74LV161A			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
V _{OH}	I _{OH} = –50 μA	2 V to 5.5 V	V _{CC} –0.1			V _{CC} –0.1			V
	I _{OH} = –2 mA	2.3 V	2			2			
	I _{OH} = –6 mA	3 V	2.48			2.48			
	I _{OH} = –12 mA	4.5 V	3.8			3.8			
V _{OL}	I _{OL} = 50 μA	2 V to 5.5 V	0.1			0.1			V
	I _{OL} = 2 mA	2.3 V	0.4			0.4			
	I _{OL} = 6 mA	3 V	0.44			0.44			
	I _{OL} = 12 mA	4.5 V	0.55			0.55			
I _I	V _I = 5.5 V or GND	0 to 5.5 V	±1			±1			μA
I _{CC}	V _I = V _{CC} or GND, I _O = 0	5.5 V	20			20			μA
I _{off}	V _I or V _O = 0 to 5.5 V	0	5			5			μA
C _i	V _I = V _{CC} or GND	3.3 V	1.8			1.8			pF

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timing requirements over recommended operating free-air temperature range, $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)

			T _A = 25°C		SN54LV161A		SN74LV161A		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t _w	Pulse duration	CLK high or low	7		7		7		ns
		$\overline{\text{CLR}}$ low	7		7		7		
t _{su}	Setup time before CLK↑	$\overline{\text{CLR}}$	4.5		4.5		4.5		ns
		Data (A, B, C, and D)	7.5		8.5		8.5		
		ENP, ENT	9.5		11		11		
		$\overline{\text{LOAD}}$ low	10		11.5		11.5		
t _h	Hold time, all synchronous inputs after CLK↑		1.5		1.5		1.5		ns

timing requirements over recommended operating free-air temperature range, $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

		$T_A = 25^{\circ}\text{C}$		SN54LV161A		SN74LV161A		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	
t_w	Pulse duration	CLK high or low	5		5		5	ns
		$\overline{\text{CLR}}$ low	5		5		5	
t_{su}	Setup time before CLK↑	$\overline{\text{CLR}}$	2.5		2.5		2.5	ns
		Data (A, B, C, and D)	5.5		6.5		6.5	
		ENP, ENT	7.5		9		9	
		$\overline{\text{LOAD}}$ low	8		9.5		9.5	
t_h	Hold time, all synchronous inputs after CLK↑		1		1		1	ns

timing requirements over recommended operating free-air temperature range, $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

			T _A = 25°C		SN54LV161A		SN74LV161A		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	
t _w	Pulse duration	CLK high or low	5		5		5		ns
		$\overline{\text{CLR}}$ low	5		5		5		
t _{su}	Setup time before CLK↑	$\overline{\text{CLR}}$	1.5		1.5		1.5		ns
		Data (A, B, C, and D)	4.5		4.5		4.5		
		ENP, ENT	5		6		6		
		$\overline{\text{LOAD}}$ low	5		6		6		
t _h	Hold time, all synchronous inputs after CLK↑		1		1		1		ns

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SN54LV161A, SN74LV161A 4-BIT SYNCHRONOUS BINARY COUNTERS

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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV161A		SN74LV161A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
$f_{\max}$			$C_L = 15\text{ pF}$	50*	125*		40*		40		MHz
			$C_L = 50\text{ pF}$	30	95		25		25		
t_{pd}	CLK	Q	$C_L = 15\text{ pF}$		7.9*	16.2*	1*	19.5*	1	19.5	ns
		RCO (count mode)			8.9*	17*	1*	20.5*	1	20.5	
		RCO (preset mode)			11.9*	20.6*	1*	24.5*	1	24.5	
	ENT	RCO			8.3*	15.7*	1*	19*	1	19	
t_{PHL}	$\overline{\text{CLR}}$	Q			8.8*	17*	1*	20.5*	1	20.5	
		RCO			9.8*	16.6*	1*	20*	1	20	
t_{pd}	CLK	Q	$C_L = 50\text{ pF}$		10.5	19.2	1	22.5	1	22.5	ns
		RCO (count mode)			11.7	20	1	23.5	1	23.5	
		RCO (preset mode)			14.5	23.6	1	27.5	1	27.5	
	ENT	RCO			11	18.7	1	22	1	22	
t_{PHL}	$\overline{\text{CLR}}$	Q			11.4	20	1	23.5	1	23.5	
		RCO			12.6	19.6	1	23	1	23	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

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4-BIT SYNCHRONOUS BINARY COUNTERS

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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV161A		SN74LV161A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			$C_L = 15\text{ pF}^*$	80*	165*		70*		70		MHz
			$C_L = 50\text{ pF}$	55	125		50		50		
t_{pd}^*	CLK	Q	$C_L = 15\text{ pF}$	6	12.8		1*	15*	1	15	ns
		RCO (count mode)		6.7	13.6		1*	16*	1	16	
		RCO (preset mode)		8.6	17.2		1*	20*	1	20	
	ENT	RCO		6.2	12.3		1*	14.5*	1	14.5	
t_{PHL}^*	$\overline{\text{CLR}}$	Q		6.5	13.6		1*	16*	1	16	
		RCO		7.2	13.2		1*	15.5*	1	15.5	
t_{pd}	CLK	Q	$C_L = 50\text{ pF}$	7.8	16.3		1	18.5	1	18.5	ns
		RCO (count mode)		8.7	17.1		1	19.5	1	19.5	
		RCO (preset mode)		10.6	20.7		1	23.5	1	23.5	
	ENT	RCO		8.3	15.8		1	18	1	18	
t_{PHL}	$\overline{\text{CLR}}$	Q		8.4	17.1		1	19.5	1	19.5	
		RCO		9.2	16.7		1	19	1	19	

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switching characteristics over recommended operating free-air temperature range,
 $V_{CC} = 5\text{ V} \pm 0.5\text{ V}$ (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	$T_A = 25^\circ\text{C}$			SN54LV161A		SN74LV161A		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
f_{max}			$C_L = 15\text{ pF}$	135*	220		115*		115		MHz
			$C_L = 50\text{ pF}$	95	165		85		85		
t_{pd}	CLK	Q	$C_L = 15\text{ pF}$	4.5*	8.1*		1*	9.5*	1	9.5	ns
		RCO (count mode)		5.1*	8.1*		1*	9.5*	1	9.5	
		RCO (preset mode)		6.3*	10.3*		1*	12*	1	12	
	ENT	RCO		4.8*	8.1*		1*	9.5*	1	9.5	
t_{PHL}	$\overline{\text{CLR}}$	Q		4.9*	9*		1*	10.5*	1	10.5	
		RCO		5.5*	8.6*		1*	10*	1	10	
t_{pd}	CLK	Q	$C_L = 50\text{ pF}$	5.9	10.1		1	11.5	1	11.5	ns
		RCO (count mode)		6.6	10.1		1	11.5	1	11.5	
		RCO (preset mode)		7.8	12.3		1	14	1	14	
	ENT	RCO		6.1	10.1		1	11.5	1	11.5	
t_{PHL}	$\overline{\text{CLR}}$	Q		6.3	11		1	12.5	1	12.5	
		RCO		6.9	10.6		1	12	1	12	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

noise characteristics, $V_{CC} = 3.3\text{ V}$, $C_L = 50\text{ pF}$, $T_A = 25^\circ\text{C}$ (see Note 5)

PARAMETER		SN74LV161A			UNIT
		MIN	TYP	MAX	
$V_{OL(P)}$	Quiet output, maximum dynamic V_{OL}		0.3	0.8	V
$V_{OL(V)}$	Quiet output, minimum dynamic V_{OL}		-0.2	-0.8	V
$V_{OH(V)}$	Quiet output, minimum dynamic V_{OH}		3		V
$V_{IH(D)}$	High-level dynamic input voltage	2.31			V
$V_{IL(D)}$	Low-level dynamic input voltage		0.99		V

NOTE 5: Characteristics are for surface-mount packages only.

operating characteristics, $T_A = 25^\circ\text{C}$

PARAMETER		TEST CONDITIONS	V_{CC}	TYP	UNIT
C_{pd}	Power dissipation capacitance	$C_L = 50\text{ pF}$, $f = 10\text{ MHz}$	3.3 V	23.6	pF
			5 V	25.8	

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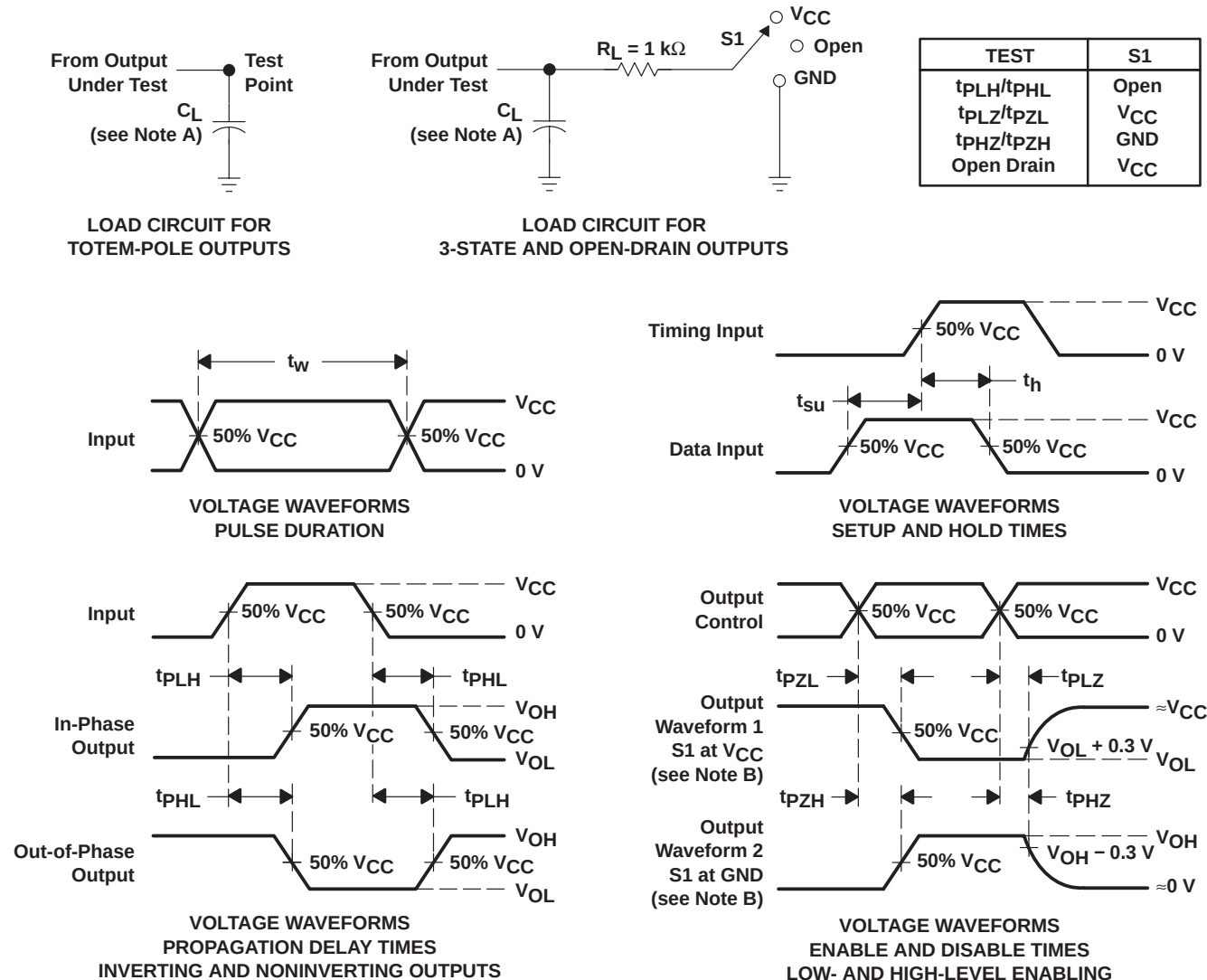


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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- C_L includes probe and jig capacitance.
 - Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
 - All input pulses are supplied by generators having the following characteristics: $PRR \leq 1\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 3\text{ ns}$, $t_f \leq 3\text{ ns}$.
 - The outputs are measured one at a time, with one input transition per measurement.
 - t_{PLZ} and t_{PHZ} are the same as t_{dis} .
 - t_{PZL} and t_{PZH} are the same as t_{en} .
 - t_{PHL} and t_{PLH} are the same as t_{pd} .
 - All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN74LV161AD	Obsolete	Production	SOIC (D) 16	-	-	Call TI	Call TI	-40 to 85	LV161A
SN74LV161ADBR	Active	Production	SSOP (DB) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161ADBR.A	Active	Production	SSOP (DB) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161ADGVR	Active	Production	TVSOP (DGV) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161ADGVR.A	Active	Production	TVSOP (DGV) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161ADR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161ADR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161ANSR	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	74LV161A
SN74LV161ANSR.A	Active	Production	SOP (NS) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	74LV161A
SN74LV161APW	Obsolete	Production	TSSOP (PW) 16	-	-	Call TI	Call TI	-40 to 85	LV161A
SN74LV161APWR	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU SN	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161APWR.A	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161APWRG4	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	No	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161APWRG4	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161APWRG4.A	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161APWRG4.A	Active	Production	TSSOP (PW) 16	2000 LARGE T&R	No	NIPDAU	Level-1-260C-UNLIM	-40 to 85	LV161A
SN74LV161APWT	Obsolete	Production	TSSOP (PW) 16	-	-	Call TI	Call TI	-40 to 85	LV161A

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

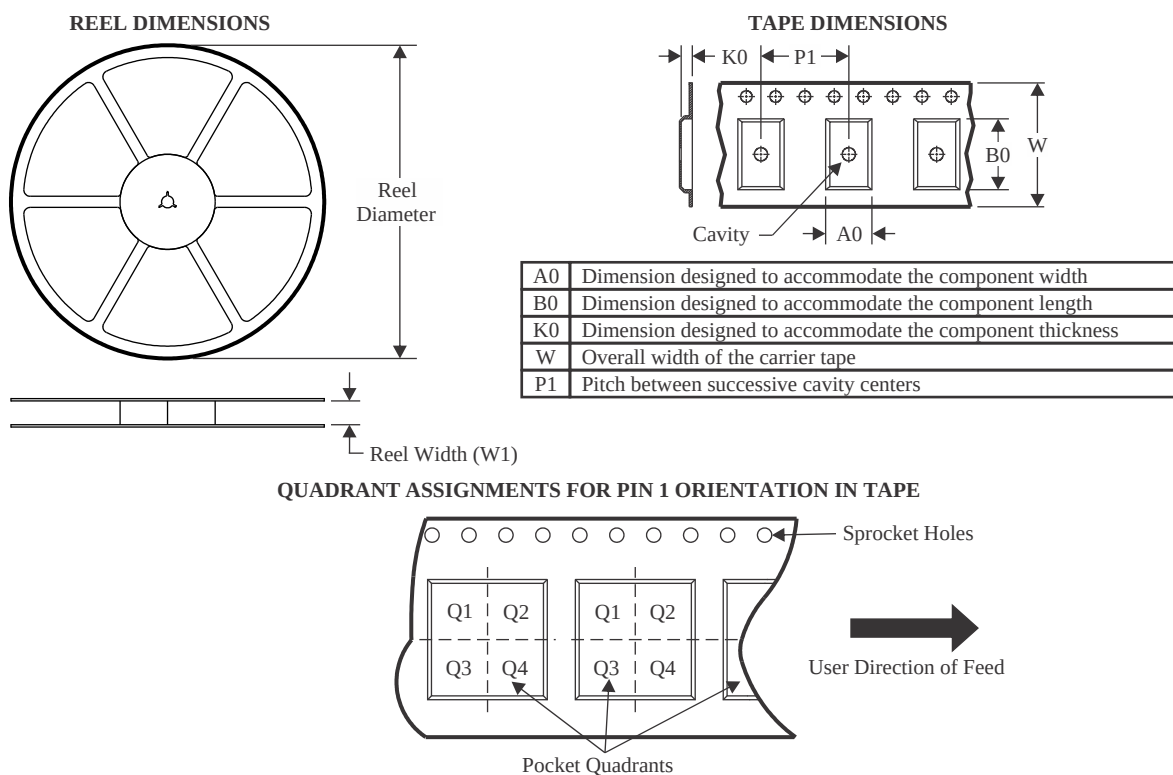
(6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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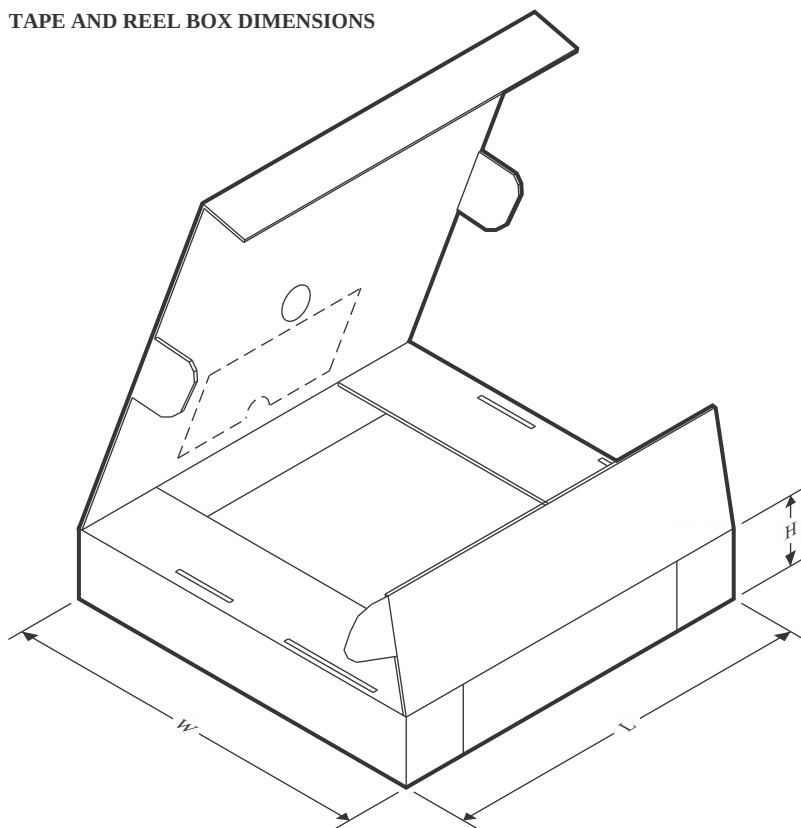
TAPE AND REEL INFORMATION



*All dimensions are nominal

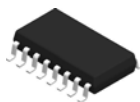
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LV161ADBR	SSOP	DB	16	2000	330.0	16.4	8.35	6.6	2.4	12.0	16.0	Q1
SN74LV161ADGVR	TVSOP	DGV	16	2000	330.0	12.4	6.8	4.0	1.6	8.0	12.0	Q1
SN74LV161ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LV161ANSR	SOP	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1
SN74LV161APWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LV161APWR	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LV161APWRG4	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
SN74LV161APWRG4	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LV161ADBR	SSOP	DB	16	2000	356.0	356.0	35.0
SN74LV161ADGVR	TVSOP	DGV	16	2000	356.0	356.0	35.0
SN74LV161ADR	SOIC	D	16	2500	353.0	353.0	32.0
SN74LV161ANSR	SOP	NS	16	2000	356.0	356.0	35.0
SN74LV161APWR	TSSOP	PW	16	2000	356.0	356.0	35.0
SN74LV161APWR	TSSOP	PW	16	2000	356.0	356.0	35.0
SN74LV161APWRG4	TSSOP	PW	16	2000	356.0	356.0	35.0
SN74LV161APWRG4	TSSOP	PW	16	2000	356.0	356.0	35.0

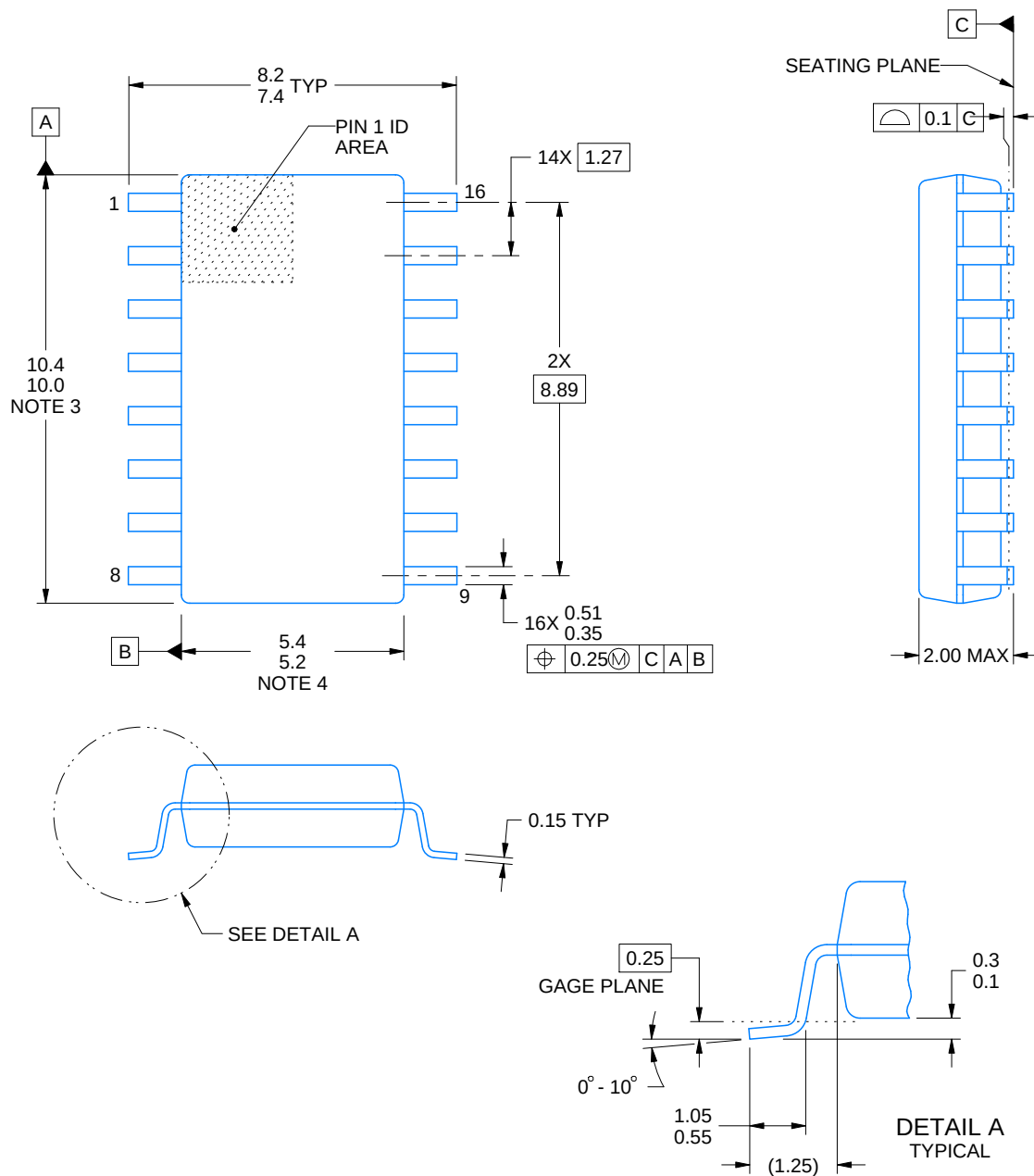


PACKAGE OUTLINE

NS0016A

SOP - 2.00 mm max height

SOP



4220735/A 12/2021

NOTES:

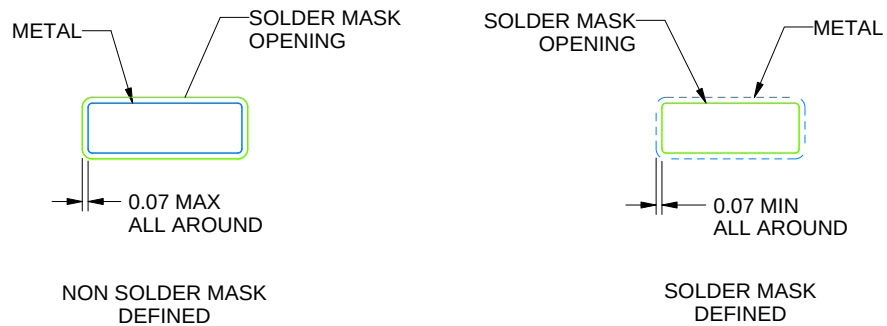
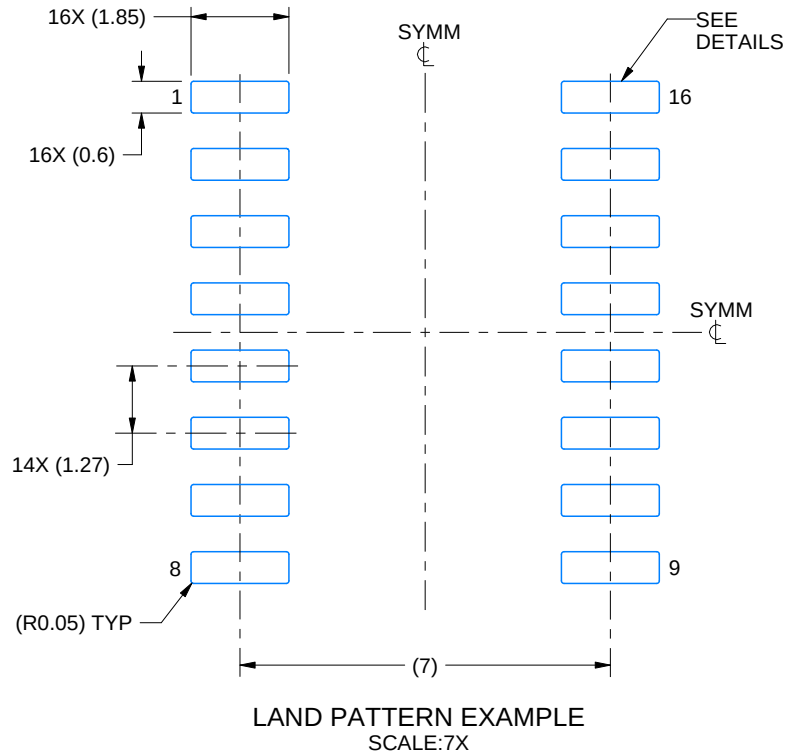
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.

EXAMPLE BOARD LAYOUT

NS0016A

SOP - 2.00 mm max height

SOP



SOLDER MASK DETAILS

4220735/A 12/2021

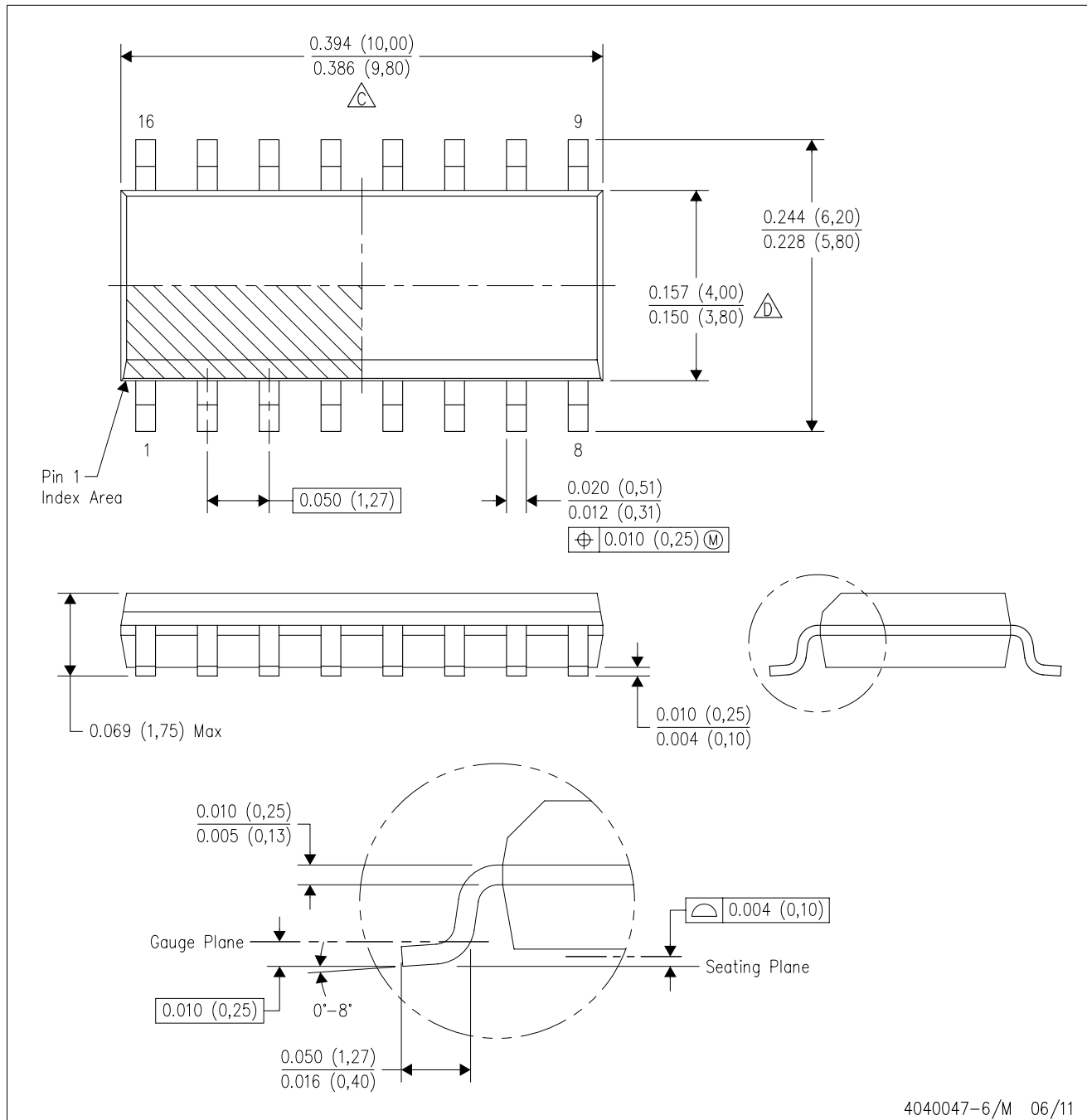
NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

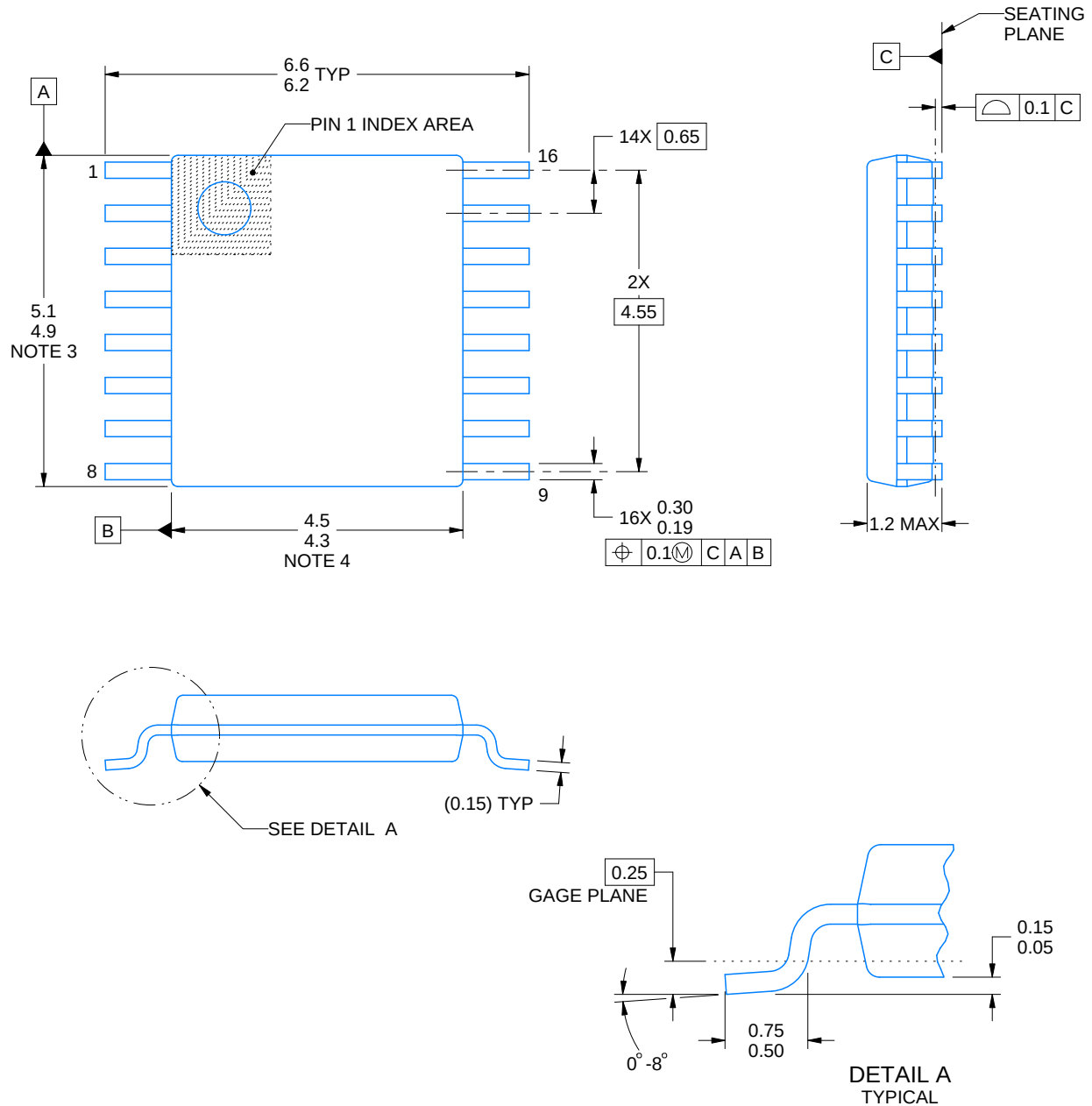
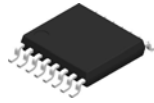
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 - D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.



4220204/A 02/2017

NOTES:

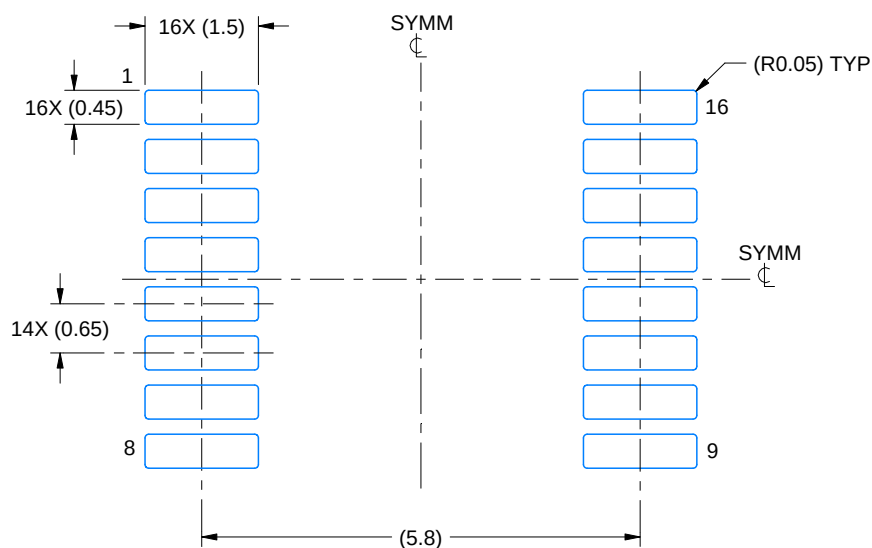
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

EXAMPLE BOARD LAYOUT

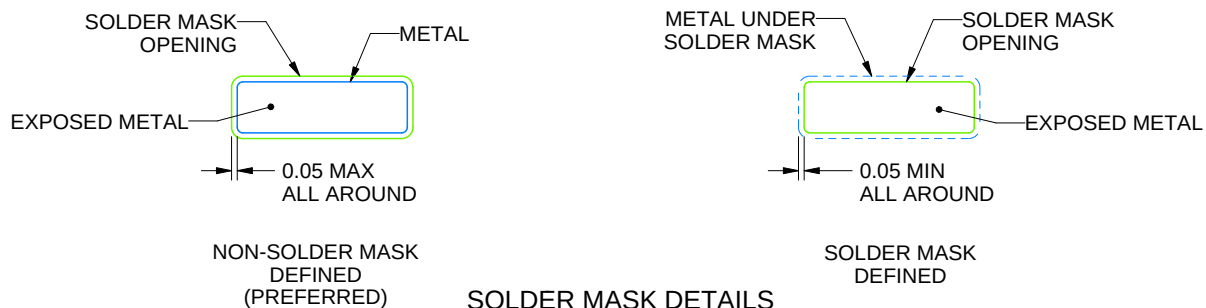
PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



4220204/A 02/2017

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

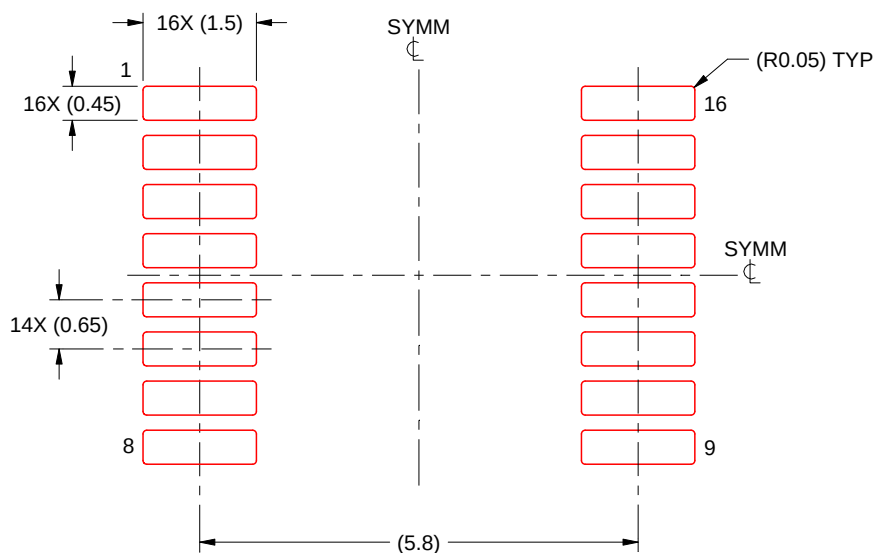
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE

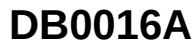


SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

4220204/A 02/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



SSOP - 2 mm max height

Technical drawing of a connector housing, showing three views: front, side, and detail A.

Front View:

- Overall width: 8.2 TYP (7.4 MIN)
- Overall height: 6.5 (5.9 MIN) (NOTE 3)
- Pin 1 Index Area (Circular feature)
- Pin 16 (Right side)
- Pin 8 (Left side)
- Pin 9 (Bottom center)
- Pin 14X 0.65 (Right side)
- Pin 2X 4.55 (Right side)
- Pin 16X 0.38 0.22 (Bottom center)
- Pin 5.6 (5.0 MIN) (NOTE 4) (Bottom center)
- Pin 0.1 (0.05 MIN) (Bottom center)
- Pin 0.25 (0.09 MIN) (Bottom center)
- Pin 0.95 (0.55 MIN) (Bottom center)
- Pin 2 MAX (Bottom center)
- Pin 0.05 MIN (Bottom center)

Side View:

- Seating Plane (Right side)
- Pin 0.1 (0.05 MIN) (Right side)
- Pin 0.25 (0.09 MIN) (Right side)
- Pin 0.95 (0.55 MIN) (Right side)
- Pin 2 MAX (Right side)
- Pin 0.05 MIN (Right side)

Detail A (Typical):

- Gage Plane (Top center)
- Pin 0.25 (0.09 MIN) (Top center)
- Pin 0.09 (0.05 MIN) (Top center)
- Pin 0.95 (0.55 MIN) (Top center)
- Pin 2 MAX (Top center)
- Pin 0.05 MIN (Top center)
- Pin 0°-8° (Top center)

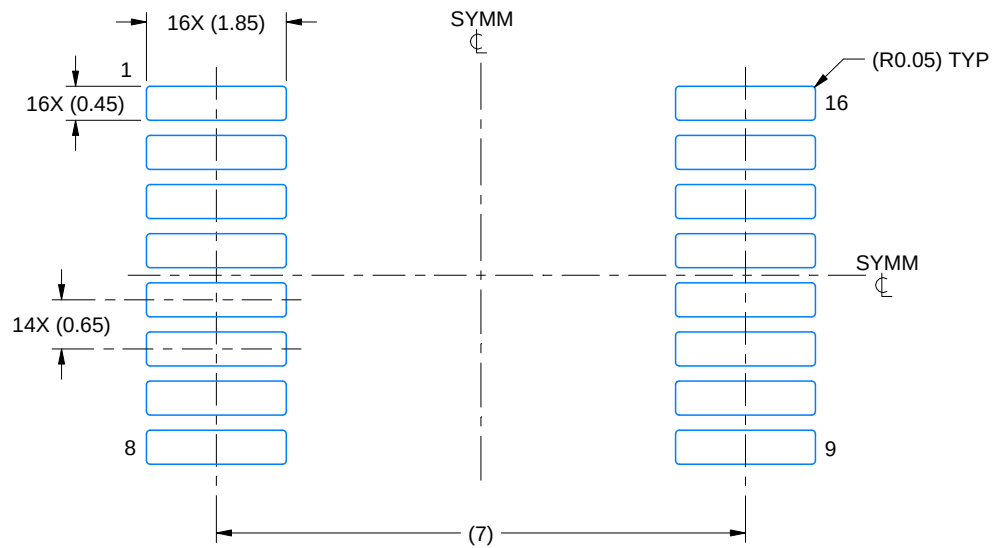
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MO-150.

EXAMPLE BOARD LAYOUT

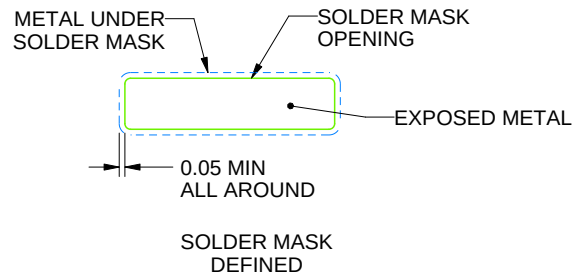
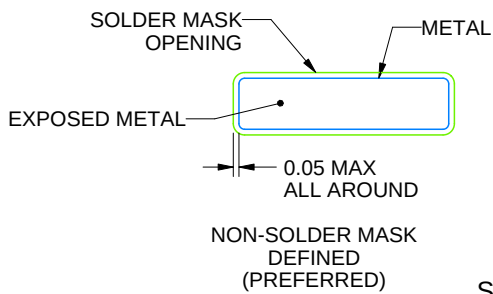
DB0016A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 10X



SOLDER MASK DETAILS

4220763/A 05/2022

NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

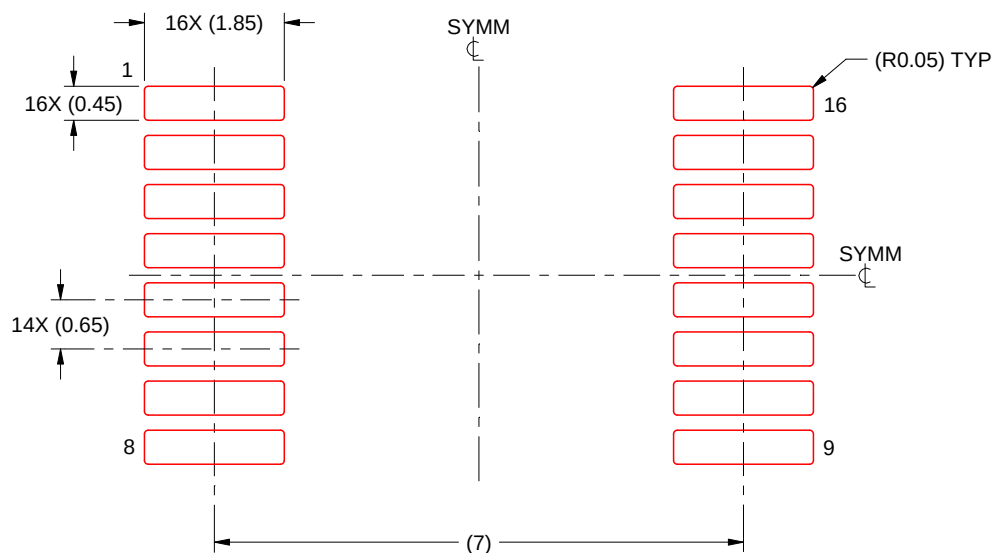
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

EXAMPLE STENCIL DESIGN

DB0016A

SSOP - 2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE: 10X

4220763/A 05/2022

NOTES: (continued)

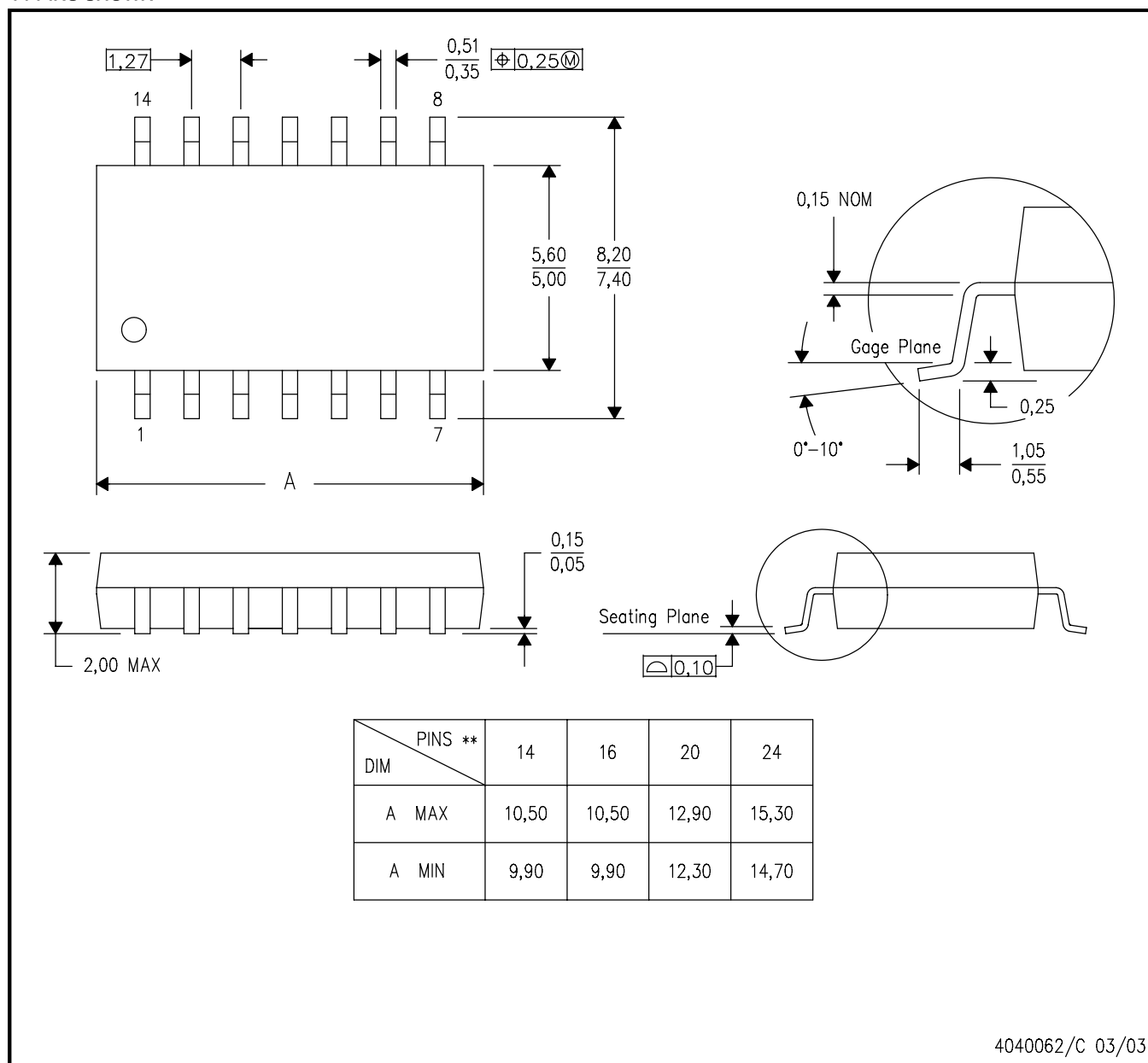
7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

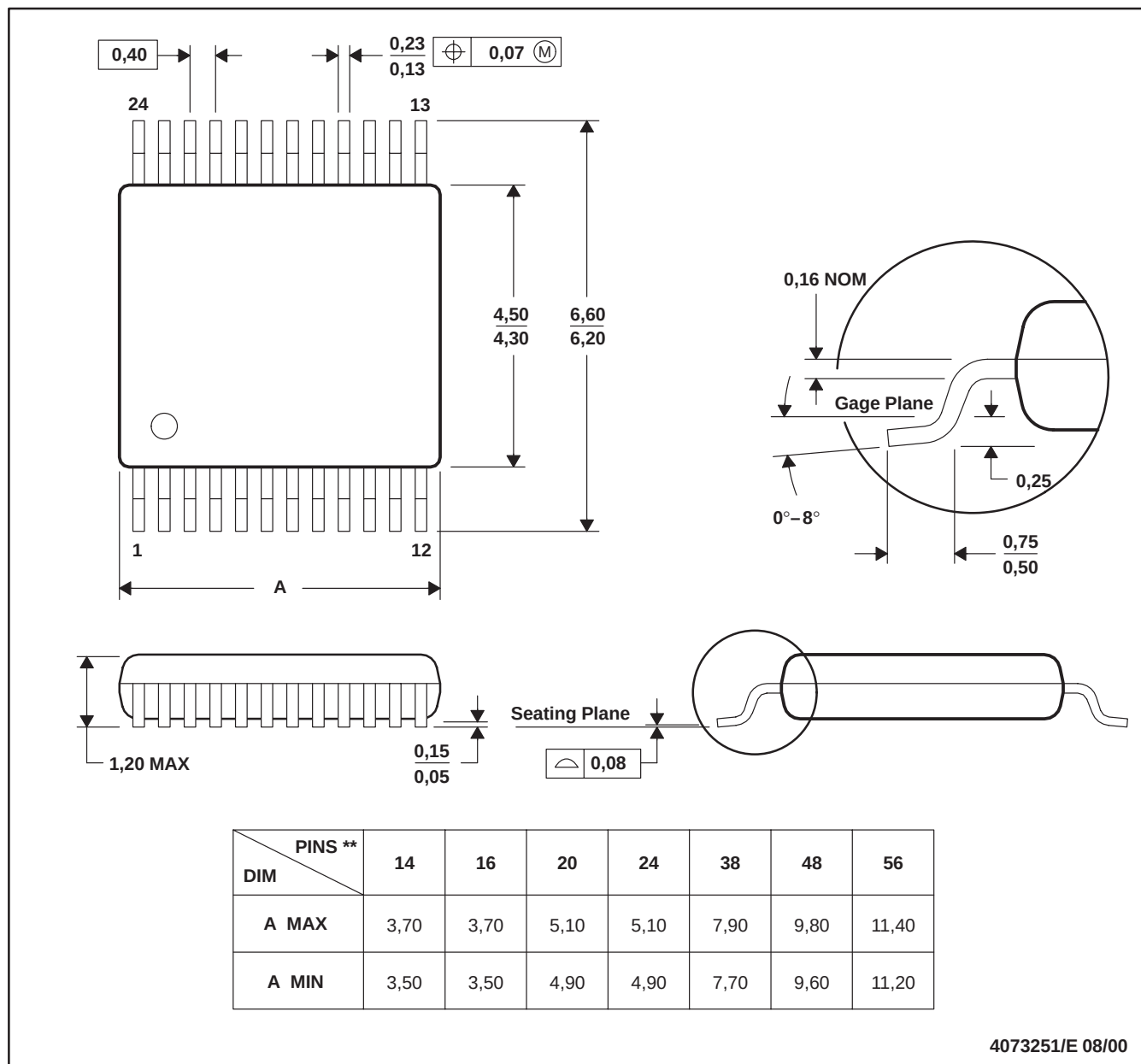


- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

DGV (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

24 PINS SHOWN



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
 - Falls within JEDEC: 24/48 Pins – MO-153
14/16/20/56 Pins – MO-194

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